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$\sqrt{\textsf{RoHS}}$

Xtrinsic MMA26xxNKW DSI Inertial Sensor

The MMA26xxNKW family, a SafeAssure solution, includes DSI2.5 compatible overdamped X-axis satellite accelerometers.

Features

- ±25g to ±312.5g Nominal Full-Scale Range
- Selectable 180 Hz, 2-pole, 400 Hz, 4-pole, or 800 Hz, 4-pole LPF
- DSI2.5 Compatible with full support of Mandatory Commands
- 16 μs internal sample rate, with interpolation to 1 ms
- -40°C to 125°C Operating Temperature Range
- Pb-Free 16-Pin QFN, 6 by 6 Package
- Qualified AECQ100, Revision G, Grade 1 (-40°C to +125°C) (http://www.aecouncil.com/)

Typical Applications

• Airbag Front and Side Crash Detection

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For user register array programming, please consult your Freescale representative.

Application Diagram

Figure 1. Application Diagram

Device Orientation

EARTH GROUND

Figure 2. Device Orientation Diagram

Internal Block Diagram

Figure 3. Block Diagram

1 Pin Connections

Figure 4. Pinout

Table 1. Pin Description

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2 Electrical Characteristics

2.1 Maximum Ratings

Maximum ratings are the extreme limits to which the device can be exposed without permanently damaging it. Do not apply voltages higher than those shown in the table below.

2.2 Operating Range

The operating ratings are the limits normally expected in the application.

2.3 Electrical Characteristics - Supply and I/O

 $V_L \leq (V_{CC} - V_{SS}) \leq V_H$, $T_L \leq T_A \leq T_H$, $\Delta T \leq 25$ K/min, unless otherwise specified.

2.4 Electrical Characteristics - DSI

2.5 Electrical Characteristics - Signal Chain

2.6 Electrical Characteristics - Self-Test and Overload

2.7 Dynamic Electrical Characteristics - DSI

2.8 Dynamic Electrical Characteristics - Signal Chain

 $V_L \le (V_{CC} - V_{SS}) \le V_H$, $T_L \le T_A \le T_H$, $\Delta T \le 25$ K/min, unless otherwise specified.

Notes:

1. Parameters tested 100% at final test at -40°C, 25°C, and 105°C.

2. Parameters tested 100% at probe.

3. Verified by characterization.

4. * Indicates critical characteristic.

5. Verified by qualification testing, not tested in production.

6. Parameters verified by pass/fail testing in production.

7. Functionality guaranteed by modeling, simulation and/or design verification. Circuit integrity assured through IDDQ and scan testing. Timing is determined by internal system clock frequency.

8. Verified by user system level characterization, not tested in production, or at component level.

9. Verified by Simulation.

10.Measured at final test. Self-test activation occurs under control of the test program.

11.Thermal resistance between the die junction and the exposed pad; cold plate is attached to the exposed pad.

12.Maximum voltage characterized. Minimum voltage tested 100% at final test. Maximum voltage tested 100% to 24V at final test. 13.N/A.

14.Sensitivity, and overload capability specifications will be reduced when 80Hz filter is selected.

15.Filter cutoff frequencies are directly dependent upon the internal oscillator frequency.

16.Target values. Actual values to be determined during device characterization.

Figure 6. VREG Under-Voltage Detection

Figure 7. VREGA Under-Voltage Detection

Figure 8. DSI Bus Inter-frame Timing

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3 Functional Description

3.1 User Accessible Data Array

A user accessible data array allows for each device to be customized. The array consists of an OTP factory programmable array, an OTP user programmable array, and read only registers for device status. The OTP arrays incorporate independent error detection circuitry for fault detection (reference [Section 3.2\)](#page-16-0). Portions of the factory programmable array are reserved for factoryprogrammed trim values. The user accessible data is shown in the table below.

Type codes

F: Freescale programmed OTP location

U/F: User and/or Freescale programmed OTP location.

Note: Unused and Unprogrammed Spare bits always read '0'.

3.1.1 Device Serial Number Registers

A unique serial number is programmed into the serial number registers of each device during manufacturing. The serial number is composed of the following information:

Serial numbers begin at 1 for all produced devices in each lot, and are sequentially assigned. Lot numbers begin at 1 and are sequentially assigned. No lot will contain more devices than can be uniquely identified by the 13-bit serial number. Depending on lot size and quantities, all possible lot numbers and serial numbers may not be assigned.

The serial number registers are included in the factory programmed OTP CRC verification. Reference [Section 3.2.1](#page-16-1) for details regarding the CRC verification. Beyond this, the contents of the serial number registers have no impact on device operation or performance, and are only used for traceability purposes.

3.1.2 Device Type Register (TYPE)

The Device Type Register is an OTP configuration register which contains device configuration information. Bit 5 - Bit 0 are factory programmed and are included in the factory programmed OTP CRC verification. These bits are read only to the user. Bit 7 - Bit 6 are user programmable OTP bits and are included in the user programmable OTP error detection.

Table 3. Factory Configuration Register

3.1.2.1 Low-Pass Filter Selection Bits (LPF[1:0]) (TYPE[7:6])

The Low-Pass Filter selection bit selects between one of three low-pass filter options. These bits can be factory or user programmed.

This filter option is not implemented. LPF[1:0] must not be set to this value to guarantee proper operation and performance.

3.1.2.2 Range Selection Bits (RNG[3:0]) (TYPE[3:0])

The Range Selection Bits indicate the full-scale range of the device, as shown below. These bits are factory programmed.

3.1.3 Device Configuration Register (DEVCFG)

The Device configuration register is a user programmable OTP register which contains device configuration information. This register is included in the user register error detection. Refer to [Section 3.2.2](#page-16-2) for details regarding the user programmable OTP array error detection.

Table 4. Device Configuration Register

3.1.3.1 Device ID Bit (DEVCFG[7])

The Device ID Bit is a user programmable bit which allows the user to select between two device IDs. The Device ID is transmitted in response to the Request ID DSI command. Reference [Section 4.2.1.5](#page-33-0) for more information regarding the Request ID DSI command. This bit can be factory or user programmed.

3.1.4 Device Configuration Register 1 (DEVCFG1)

The Device configuration register is a user programmable OTP register which contains device configuration information. This register is included in the user register error detection. Refer to [Section 3.2.2](#page-16-2) for details.

Table 5. Device Configuration Register 1

3.1.4.1 Attribute Bits (AT_OTP[1:0], DEVCFG1[1:0])

The Attribute Bits are user defined bits which are transmitted in response to the Request Status, Disable Self-Test Stimulus or Enable Self-Test Stimulus DSI commands. The transmitted values are qualified by the LOCK_U bit as shown in the table below. These bits can be factory or user programmed.

3.1.5 Device Configuration Register 2 (DEVCFG2)

Device configuration register 2 is a user programmable OTP register which contains device configuration information. This register is included in the user register error detection. Refer to [Section 3.2.2](#page-16-2) for details.

Table 6. Device Configuration Register 2

3.1.5.1 User Configuration Lock Bit (LOCK_U, DEVCFG2[7])

The LOCK_U bit is a factory or user programmed OTP bit which inhibits writes to the user configuration array when active. Reference [Section 3.2.2](#page-16-2) for details regarding the LOCK_U bit and error detection.

3.1.5.2 PCM Bit (DEVCFG2[5])

The PCM Bit enables the PCM output pin. When the PCM bit is set, the PCM output pin is active and outputs a Pulse Code Modulated signal proportional to the acceleration response. Reference [Section 3.5.3.6](#page-25-0) for more information regarding the PCM output. When the PCM output is cleared, the PCM output pin is actively pulled low. This bit can be factory or user programmed.

3.1.5.3 Device Address (ADDR[3:0], DEVCFG2[3:0])

The Device Address bits define the preprogrammed DSI Bus device address. If the Device Address bits are programmed to '0000', there is not preprogrammed address, and the address must be assigned via the Initialization DSI command. Reference [Section 4.2.1.1](#page-29-0) for more details regarding the Initialization DSI command. These bits can be factory or user programmed.

3.1.6 User Data Registers (UDx)

The User Data Registers are user programmable OTP register which can be programmed with user or assembly specific information. These registers have no impact on the device performance, but are included in the user register error detection. Refer to [Section 3.2.2](#page-16-2) for details.

3.2 OTP Array Lock and Error Detection

3.2.1 Factory Programmed OTP Array Lock and Error Detection

The Factory programmed OTP array is verified for errors with a 3-bit CRC. The CRC verification is enabled only when the Factory programmed OTP array is locked and the lock is active. The lock is active only after an automatic OTP readout in which the internal lock bit is read as '1'. Automatic OTP readouts occur only after POR or a DSI Clear Command is received.

The Factory programmed OTP array is locked by Freescale and will always be active after POR. The CRC is continuously calculated on the factory programmed OTP array, which includes the registers listed below:

Bits are fed in from right to left (LSB first), and top to bottom (lower addresses first) in the register map. The CRC verification uses a generator polynomial of $g(x) = X^3 + X + 1$, with a seed value = '111'. The calculated CRC is compared against the CRC F[2:0] bits. If a CRC mismatch is detected, an internal data error is set and the device responds to DSI messages as spec-ified in [Section 4.3.](#page-41-0) The CRC verification is completed on the memory registers which hold a copy of the fuse array values, not the fuse array values.

3.2.2 User Programmable OTP Array Lock and Error Detection

The User Programmable OTP array is independently verified for errors. The error detection is enabled only when the User Programmable OTP array is locked as shown below.

When the LOCK_U bit is set, the error detection is calculated on the user programmable OTP Array registers listed below and stored to NVM.

During normal operation, the error detection code is continuously compared against the stored error detection code. If a mismatch is detected, an internal data error is set, and the device responds to DSI messages as specified in [Section 4.3.](#page-41-0) The error detection code is calculated on the memory registers which hold a copy of the fuse array values, not the fuse array values.

Writes to the User Programmable OTP array using the Write NVM Command will update the mirror registers and result in a change to the error detection code regardless of the state of the LOCK_U bit. An error detection mismatch will only be detected if the LOCK_U bit is active.

3.3 Voltage Regulators

The device derives its internal supply voltage from the HCAP supply voltage. The device includes separate internal voltage regulators for the analog (V_{RFGA}) and digital circuitry (V_{RFG}). External filter capacitors are required, as shown in Figure 1.

The voltage regulator module includes voltage monitoring circuitry which holds the device in reset following power-on until the HCAP and internal voltages have stabilized sufficiently for proper operation. The voltage monitor asserts internal reset when the HCAP supply or internally regulated voltages fall below predetermined levels. A reference generator provides a stable voltage which is used by the $\Sigma\Delta$ converter.

3.3.1 CREG and CREGA Regulator Capacitor

The internal regulator requires an external capacitor between the C_{REG} pin and V_{SS} pin, and the C_{REGA} pin and V_{SSA} pin for stability. Figure 1 shows the recommended types and values for each of these capacitors.

3.3.2 V_{HCAP} Voltage Monitor

The device includes a circuit to monitor the voltage on the HCAP pin. If the voltage falls below the specified threshold in [Section 2](#page-4-0), the device will be reset within the reset delay time $(t_{HCAP-POR})$ specified in [Section 2.7.](#page-8-0)

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3.3.3 VREG, and VREGA Under-Voltage Monitor

The device includes a circuit to monitor the internally regulated voltages (V_{REG} and V_{REG}). If either of the internal regulator voltages fall below the specified thresholds in [Section 2](#page-4-0), the device will be reset within the reset delay time (t_{VREG_POR}, t_{VREGA_POR}) specified in [Section 2.7.](#page-8-0)

3.3.4 VREG and VREGA Capacitance Monitor

A monitor circuit is incorporated to ensure predictable operation if the connection to the external C_{REG} or C_{REGA} capacitor becomes open. At a continuous rate specified in [Section 2.7](#page-8-0) (t_{CAPTEST_RATE}), both regulators are simultaneously disabled for a short duration (t_{CAPTEST_TIME}). If either of the external capacitors are not present, the associated regulator voltage will fall below the internal reset threshold, forcing a device reset.

3.4 Internal Oscillator

The device includes a factory trimmed oscillator as specified in [Section 2.8.](#page-9-0)

3.5 Acceleration Signal Path

3.5.1 Transducer

The device transducer is an overdamped mass-spring-damper system described by the following transfer function: where:

$$
H(s) = \frac{\omega_n^2}{s^2 + 2 \cdot \xi \cdot \omega_n \cdot s + \omega_n^2}
$$

ζ = Damping Ratio

ωn = Natural Frequency = 2∗Π∗*f*ⁿ

Reference [Section 2.8](#page-9-0) for transducer parameters.

3.5.2 ΣΔ **Converter**

The sigma delta converter provides the interface between the g-cell and the DSP block. The output of the $\Sigma\Delta$ converter is a data stream at a nominal frequency of 1 MHz.

Figure 12. ΣΔ **Converter Block Diagram**

3.5.3 Digital Signal Processing Block

A digital signal processing (DSP) block is used to perform signal filtering and compensation operations. A diagram illustrating the signal processing flow within the DSP block is shown in Figure 13.

Figure 13. Signal Chain Diagram

Table 7. Signal Chain Characteristics

3.5.3.1 Decimation Sinc Filter

The serial data stream produced by the ΣΔ converters is decimated and converted to parallel values by a 3rd order 16:1 sinc filter with a decimation factor of 16.

$$
H(z) = \left[\frac{1 - z^{-16}}{16 \times (1 - z^{-1})}\right]^3
$$

Figure 14. Sinc Filter Response, $t_s = 16 \mu s$

3.5.3.2 Low-Pass Filter

Data from the Sinc filter is processed by an infinite impulse response (IIR) low-pass filter.

$$
H(z) = a_0 \cdot \frac{(n_{11} \cdot z^0) + (n_{12} \cdot z^{-1}) + (n_{13} \cdot z^{-2})}{(d_{11} \cdot z^0) + (d_{12} \cdot z^{-1}) + (d_{13} \cdot z^{-2})} \cdot \frac{(n_{21} \cdot z^0) + (n_{22} \cdot z^{-1}) + (n_{23} \cdot z^{-2})}{(d_{11} \cdot z^0) + (d_{22} \cdot z^{-1}) + (d_{23} \cdot z^{-2})}
$$

The device provides the option for one of three low-pass filters. The filter is selected with the LPF[1:0] bits in the TYPE register. The filter selection options are listed in [Section 3.1.2.1,](#page-13-0) [Table 8.](#page-21-1) Response parameters for the low-pass filter are specified in [Section 2.8](#page-9-0). Filter characteristics are illustrated in the figures below.

Table 8. Low-Pass Filter Coefficients

Note: Low-Pass Filter Figures do not include g-cell frequency response.

Figure 15. Low-Pass Filter Characteristics: f_C **= 180 Hz, 2-Pole,** t_S **= 16 μs**

Figure 16. Low-Pass Filter Characteristics: $f_C = 400$ **Hz, 4-Pole,** $t_S = 16$ **μs**

Figure 17. Low-Pass Filter Characteristics: f_C **= 800 Hz, 4-Pole,** t_S **= 16 μs**

3.5.3.3 Compensation

The device includes internal compensation circuitry to compensate for sensor offset, sensitivity and non-linearity.

3.5.3.4 Data Interpolation

The device includes 16 to 1 linear data interpolation to minimize the system sample jitter. Each result produced by the digital signal processing chain is delayed one sample time. On reception of an acceleration data request, the transmitted data is interpolated from the 2 previous samples, resulting in a latency of one sample time, and a maximum signal jitter of ±1/16 of a sample time. Reference Figure 8 for more information regarding interpolation and data latency.

3.5.3.5 Output Scaling

The 26-bit digital output from the DSP is clipped and scaled to a 10-bit or 8-Bit word which covers the acceleration range of the device. Figure 18 shows the method used to establish the acceleration data word from the 26-bit DSP output.

Over Range				Signal										Noise			Margin				
D ₂₅	D ₂₄	D ₂₃	D ₂₂	D ₂ 1	D ₂₀	D ₁₉	D ₁₈	D ₁₇	D ₁₆	D ₁₅	D ₁₄	D ₁₃	D ₁₂	D ₁	D ₁₀	D ₉	D ₈	\cdots	D ₂	D1	D ₀
10 Bit Data Word				D ₂	D ₂₀	D ₁₉	D ₁₈	D ₁₇	D ₁₆	D ₁₅	D ₁₄	D ₁₃	D ₁₂	Using Truncation							
9 Bit Data Word				D2	D ₂₀	D ₁₉	D ₁₈	D ₁₇	D ₁₆	D ₁₅	D ₁₄	D ₁₃		Using Truncation							
8 Bit Data Word			D2	D ₂₀	D ₁₉	D ₁₈	D ₁₇	D ₁₆	D15	D ₁₄	Using Truncation										

Figure 18. Output Scaling Diagram

3.5.3.6 PCM Output Function

The device provides the option for a PCM output function. The PCM output is activated if the PCM bit is set in the DEVCFG2 register. When the PCM function is enabled, a 4 MHz Pulse Code Modulated signal proportional to the upper 9 bits of the acceleration response is output onto the PCM pin. The PCM output is intended for test use only. A block diagram of the PCM output is shown in Figure 19.

Figure 19. PCM Output Function Block Diagram

3.6 Device Initialization

Following powerup, under-voltage reset or reception of a DSI Clear Command, the device proceeds through an initialization process as described in the following tables:

Table 9. Powerup or Under-Voltage Reset Initialization Process

Table 10. DSI Clear Command Initialization Process

Figure 20. Initialization Timing

3.7 Overload Response

3.7.1 Overload Performance

The device is designed to operate within a specified range. However, acceleration beyond that range (overload) impacts the operating range output of the sensor. Acceleration beyond the range of the device can generate a DC shift at the output of the device that is dependent upon the overload frequency and amplitude. The device g-cell is overdamped, providing the optimal design for overload performance. However, the performance of the device during an overload condition is affected by many other parameters, including:

- g-cell damping
- Non-linearity
- Clipping limits
- Symmetry

Figure 21 shows the g-cell, Sigma Delta, and output clipping of the device over frequency. The relevant parameters are specified in [Section 2](#page-4-0).

Figure 21. Output Clipping Vs. Frequency

3.7.2 Sigma Delta Overrange Response

Overrange conditions exist when the signal level is beyond the full-scale range of the device but within the computational limits of the DSP. The $\Sigma\Delta$ converter can saturate at levels above those specified in [Section 2](#page-4-0) (G_{ADC, CLIP}). The DSP operates predictably under all cases of overrange, although the signal may include residual high frequency components for some time after returning to the normal range of operation due to non-linear effects of the sensor.

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4 DSI Protocol Layer

4.1 Communication Interface Overview

The device is compatible with the DSI Bus Standard V2.5.

4.1.1 DSI Physical Layer

Reference DSI Bus Standard V2.5, Section 3 for information regarding the physical layer.

4.1.2 DSI Data Link Layer

Reference DSI Bus Standard,V2.5, Section 4 for information regarding the DSI data link layer. The sections below describe the DSI data link layer features supported.

4.2 DSI Protocol

4.2.1 DSI Bus Commands

DSI Bus Commands are summarized in [Table 11](#page-28-0). The device supports only the command formats specified in [Section 4.2.1.](#page-28-1) The device will ignore commands of any other format. If a CRC error is detected, or a reserved or un-implemented command is received, the device will not respond.

Following all messages, the device requires a minimum inter-frame separation (t_{IFS}) . As long as the minimum inter-frame separation times defined in [Section 4.2.1](#page-28-1) are met, all supported commands are guaranteed to be executed, and the device will be ready for the next message. The device will respond as appropriate during the subsequent DSI transfer. Exactly one response is attempted.

Table 11. DSI Bus Command Summary

4.2.1.1 Initialization Command

The initialization command conforms to the description provided in Section 6.1.1 of the DSI Bus Standard V2.5. The initialization command is only supported as a standard long command. No other commands are recognized by the device until a valid standard long initialization command is received.

Table 12. Initialization Command

Table 13. Initialization Command Bit Definitions

If the BS bit is set in the initialization command, the device will be reset within t_{BSOPEN}.

If the device has been preprogrammed, PA[3:0] and A[3:0] must match the preprogrammed address.

If no device address has been previously programmed into the OTP array, PA[3:0] contains the device address, and A[3:0] must be zero. If either addressing condition is not met, the device address is not assigned, and the device will not respond to the Initialization command. If the addressing conditions are met, the new device address is assigned to A[3:0]. Once the device address is assigned, the new address (A[3:0]) is not protected by the User Programmable OTP Array error detection. The User Programmable OTP array error detection is calculated and verified using the OTP programmed values of A[3:0] = '0000'.

Once initialized, the device will no longer recognize or respond to Initialization commands.

Table 14. Initialization Command Response

Table 15. Initialization Response Bit Definitions

4.2.1.2 Request Status Command

The Request Status command is supported in the following command formats:

- Standard Long Command
- Standard Short Command
- Enhanced Long Command as configured by the Format Control Command (Reference [Section 4.2.1.11\)](#page-37-0)
- Enhanced Short Command as configured by the Format Control Command (Reference [Section 4.2.1.11](#page-37-0))

The device ignores the Request Status command if the DSI device address is set to the DSI Global Device Address of '0000'. The data bits D[7:0] in the command are only used in the CRC calculation.

Table 16. Request Status Command

Table 17. Request Status Command Bit Definitions

Table 18. Short Response - Request Status Command

Table 19. Long Response - Request Status Command

Table 20. Request Status Response Bit Definitions

4.2.1.3 Read Acceleration Data Command

The Read Acceleration Data command is supported in the following command formats:

- Standard Long Command
- Standard Short Command
- Enhanced Long Command as configured by the Format Control Command (Reference [Section 4.2.1.11](#page-37-0))
- Enhanced Short Command as configured by the Form at Control Command (Reference [Section 4.2.1.11](#page-37-0))

The device ignores the Request Status command if the DSI device address is set to the DSI Global Device Address of '0000'. The data bits D[7:0] in the command are only used in the CRC calculation.

Table 21. Read Acceleration Data Command

Table 22. Read Acceleration Data Command Bit Definitions

Table 23. Short Response - Read Acceleration Data Command

Table 24. Long Response - Read Acceleration Data Command

Table 25. Read Acceleration Response Bit Definitions

The device truncates the LSBs for Acceleration Data Responses of length less than 10. If the result of the truncation is 0, the minimum acceleration value is transmitted as defined in [Table 26.](#page-32-0)

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Table 26. Acceleration Data Values

4.2.1.4 DSI Command #3

DSI Command '0011' is not implemented. The device ignores all command formats with a command ID of '0011'.

4.2.1.5 Request ID Information Command

The Request ID Information command is supported in the following command formats:

- Standard Long Command
- Standard Short Command
- Enhanced Long Command as configured by the Format Control Command (Reference [Section 4.2.1.11](#page-37-0))
- Enhanced Short Command as configured by the Format Control Command (Reference [Section 4.2.1.11\)](#page-37-0)

The device ignores the Request ID Information command if the DSI device address is set to the DSI Global Device Address of '0000'. The data bits D[7:0] in the command are only used in the CRC calculation.

Table 27. Request ID Information Command

Table 28. Request ID Information Command Bit Definitions

Table 29. Short Response - Request ID Information Command

Table 30. Long Response - Request ID Information Command

Table 31. Request ID Response Bit Definitions

4.2.1.6 DSI Command #5

DSI Command '0101' is not implemented. The device ignores all command formats with a command ID of '0101'.

4.2.1.7 DSI Command #6

DSI Command '0110' is not implemented. The device ignores all command formats with a command ID of '0110'.

4.2.1.8 Clear Command

The Clear command is supported in the following command formats:

- Standard Long Command
- Standard Short Command
- Enhanced Long Command as configured by the Format Control Command (Reference [Section 4.2.1.11](#page-37-0))
- Enhanced Short Command as configured by the Format Control Command (Reference [Section 4.2.1.11\)](#page-37-0)

When the device successfully decodes a Clear Command, and the address field matches either the assigned device address (PA[3:0]) or the DSI Global address of '0000' the device logic is reset. Reference [Section 3.6](#page-26-0) for the initialization sequence following a Clear Command. The data bits D[7:0] in the command are only used in the CRC calculation. There is no response to the Clear Command.

Table 32. Clear Command

Table 33. Clear Command Bit Definitions

4.2.1.9 DSI Command #8

DSI Command '1000' is not implemented. The device ignores all command formats with a command ID of '1000'.

4.2.1.10 Write NVM Command

The Write NVM command is supported in the following command formats:

- Standard Long Command
- Enhanced Long Command as configured by the Format Control Command (Reference [Section 4.2.1.11](#page-37-0))

The device ignores the Write NVM command if the command is in any other format, or if the DSI device address is set to the DSI Global Device Address of '0000'.

The Write NVM command uses the nibble address definitions in [Table 2](#page-12-0) and summarized in [Table 39.](#page-36-0)

Table 34. Write NVM Command

Table 35. Write NVM Command Bit Definitions

Table 36. Long Response - Write NVM Command (NV = 1)

Table 37. Long Response - Write NVM Command (NV = 0)

Table 38. Write NVM Response Bit Definitions

Writes to OTP occur only if the NV bit is set. The NV bit is set by the Initialization Command (reference [Section 4.2.1.1\)](#page-29-0). If the NV bit is cleared when the command is executed, the mirror registers addressed by WA[3:0] are updated with the contents of RD[3:0] and the DSI Device Address is returned regardless of the WA[3:0] value. If the Write NVM command is a request to change the Device Address, the new Device Address is returned.

The DSI Bus idle voltage must exceed the minimum V_{PP} voltage when programming the OTP array. No internal verification of the VPP voltage is completed while writing is in process. To verify proper writes, it is recommend that the registers be read back after writes to verify proper contents. The total Execution time for the Write NVM command is t_{PROG_BIT} times the number of bits being programmed (1 - 4 bits). Inter-frame spacing between the Write NVM command and the subsequent DSI command must accommodate this timing.

Writes to the User Programmable OTP array using the Write NVM Command will update the mirror registers and result in a change to the error detection calculation regardless of the state of the NV bit and the LOCK_U bit. An error detection mismatch will only be detected if the LOCK U bit is active (reference [Section 3.2.2](#page-16-2)).

Table 39. OTP Register Nibble Address Assignments

4.2.1.11 Format Control Command

The Format Control command is supported in the following command formats:

- Standard Long Command
- Enhanced Long Command as configured by the Format Control Command (Reference [Section 4.2.1.11](#page-37-0))

The device ignores the Format Control command if the command is in any other format. The device supports the Format Control command with the DSI Global Address of '0000', but does not provide a response.

Table 40. Format Control Command

Table 41. Format Control Command Bit Definitions

Table 42. Long Response - Format Control Command

Table 43. Format Control Response Bit Definitions

The format control registers defined in the DSI Bus Standard V2.5 are shown in [Table 44.](#page-37-1) The reset values assigned to each register are also indicated.

Table 44. Format Control Register Values

The following restrictions apply to format control register operations:

- Writes to the CRC Length Register of values greater than 8 are ignored. The contents of the register are unchanged.
- Writes to the Short Word Data Length register of values less than 8 are ignored. The contents of the register are unchanged.

The contents of the Format Selection register determine whether the standard DSI values or the values in the format control registers are used. If the Format Selection register contains '1111', the Format Control register values are active. Any write to the Format Control registers will become active upon completion of the write. In this case, the response to a Format Control Command will maintain the format of the previous command resulting in an invalid response.

A write of '0000' to the Format Selection register activates the standard DSI values.

A write to the Format Selection register of any other value is ignored.

4.2.1.12 Read Register Data Command

The Read Register Data command is supported in the following command formats:

- Standard Long Command
- Enhanced Long Command as configured by the Format Control Command (Reference [Section 4.2.1.11](#page-37-0))

The device ignores the Register Data command if the command is in any other format, or if the DSI device address is set to the DSI Global Device Address of '0000'.

The read register command uses the byte address definitions shown in [Table 2.](#page-12-0) Readable registers along with their Byte addresses are shown in [Table 2.](#page-12-0)

Table 45. Read Register Data Command

Table 46. Read Register Data Command Bit Definitions

Table 47. Long Response - Read Register Data Command

Table 48. Read Register Data Response Bit Definitions

4.2.1.13 Disable Self-Test Command

The Disable Self-Test command is supported in the following command formats:

- Standard Long Command
- Standard Short Command
- Enhanced Long Command as configured by the Format Control Command (Reference [Section 4.2.1.11](#page-37-0))
- Enhanced Short Command as configured by the Format Control Command (Reference [Section 4.2.1.11\)](#page-37-0)

The data bits D[7:0] in the command are only used in the CRC calculation. The device supports the Disable Self-Test command with the DSI Global Address of '0000', but does not provide a response.

The Disable Self-Test Command removes the voltage from the self-test plate of the transducer which results in the acceleration output value returning to the 0g offset value within $t_{ST-DEACT-xxxx}$, as specified in [Section 2.](#page-4-0)

Table 49. Disable Self-Test Command

Table 50. Disable Self-Test Command Bit Definitions

Table 51. Short Response - Disable Self-Test Command

Table 52. Long Response - Disable Self-Test Command

Table 53. Disable Self-Test Response Bit Definitions

A self-test lockout is activated when the device receives two consecutive Disable Self-Test commands Once self-test lockout is activated, the internal self-test circuitry is disabled until one of the following conditions occurs:

- HCAP under-voltage
- A Clear command is received
- Internal regulator under-voltage resulting in a reset
- A Frame Timeout resulting in a reset

4.2.1.14 Enable Self-Test Command

The Enable Self-Test command is supported in the following command formats:

- Standard Long Command
- Standard Short Command
- Enhanced Long Command as configured by the Format Control Command (Reference [Section 4.2.1.11](#page-37-0))
- Enhanced Short Command as configured by the Format Control Command (Reference [Section 4.2.1.11\)](#page-37-0)

The data bits D[7:0] in the command are only used in the CRC calculation. The device ignores the Enable Self-Test command when it is sent to the DSI Global Address of '0000'.

The Enable Self-Test Command applies a voltage to the self-test plate of the transducer which results in a delta in the acceleration output value of Δ DFLCT_xxx within t_{ST_ACT_xxx}, as specified in [Section 2.](#page-4-0) This remains present until the Disable Self-Test command is received.

Activation of the self-test circuit is inhibited if the self-test locking has been activated. If self-test locking is activated, the internal self-test circuitry remains disabled, and the ST bit is cleared in the response. Self-test locking is described in [Section 4.2.1.13.](#page-39-0)

Table 54. Enable Self-Test Command

Table 55. Enable Self-Test Command Bit Definitions

Table 56. Short Response - Enable Self-Test Command

Table 57. Long Response - Enable Self-Test Command

Table 58. Enable Self-Test Response Bit Definitions

4.2.1.15 DSI Command #14

DSI Command '1110' is not implemented. The device ignores all command formats with a command ID of '1110'.

4.2.1.16 Reverse Initialization Command

The Reverse Initialization Command is not implemented. The device ignores all command formats with a command ID of '1111'.

4.3 Exception Handling

[Table 59](#page-41-1) summarizes the exception conditions detected by the device and the response for each exception.

Table 59. Exception Handling

5 Package

5.1 Case Outline Drawing

Reference Freescale Case Outline Drawing # 98ASA00090D

http://www.freescale.com/files/shared/doc/package_info/98ASA00090D.pdf

5.2 Recommended Footprint

Reference Freescale Application Note AN3111, latest revision:

http://www.freescale.com/files/sensors/doc/app_note/AN3111.pdf

Table 60. Revision History

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